Toward full carbon interconnects: High conductivity of individual carbon nanotube to carbon nanotube regrowth junctions

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Carbon nanotubes (CNTs) can be used in future electronics both as interconnects\textsuperscript{1,2} and as functional elements.\textsuperscript{3} In particular, CNTs have demonstrated higher electrical conductivity and current density\textsuperscript{4,5} than Cu and could avoid difficulties foreseen in nanometer scale Cu interconnects due to electromigration and mechanical instability. Therefore CNTs are appealing candidates for wiring in electronic circuits.\textsuperscript{6} Several examples of CNT vias\textsuperscript{7,8} and interconnects\textsuperscript{9} have been reported recently. However, to develop CNT solutions for interconnects, highly conducting CNT-CNT junctions are required. As CNT to CNT cross contacts are poor,\textsuperscript{9} connections could be achieved by metal welding\textsuperscript{10} or direct CNT intermolecular Y junction.\textsuperscript{11,12} On the one hand, the electrical conductivity of CNT Y junctions has already been investigated, but only in the case of Y junctions obtained in a single growth step.\textsuperscript{13,14} However, building CNT interconnects requires the fabrication of T-type junctions by a multiple step process. On the other hand, regrowth of CNT on CNT has been demonstrated\textsuperscript{15–17} but the conductivity of those T-type junctions has not been measured and neither was their integration into CNT-wiring networks explored.

In the present paper, we describe the fabrication and electrical characterization of individual CNT junctions using chemical vapor deposition (CVD) regrowth. The selective placement of catalyst particles was achieved either by chemical coupling or by electrodirected placement. In a first approach, multiwalled CNTs (MWNTs) were functionalized either covalently with ferritin protein\textsuperscript{18} or noncovalently\textsuperscript{17,19} by hydrophobic iron oxide nanoparticles (FeO\textsubscript{x}NPs). Alternatively, bare MWNTs were first electrically connected and FeO\textsubscript{x}NPs were deposited thereon using dielectrophoresis (DEP). In all cases, MWNT-catalyst conjugates were deposited on a SiO\textsubscript{2} substrate and subsequently calcinated and reduced, yielding MWNT supported Fe(0) particles used as catalyst for the CVD growth of new MWNTs.

In order to realize and electrically connect individual CNT junctions, sample preparation had to be carefully optimized. Namely single regrown CNTs on well separated MWNTs were preferred. First, MWNT-catalyst conjugates were spread at low density on a substrate patterned with an alignment grid so that individual, well separated MWNTs could be localized. Second, the catalyst nature and grafting yield as well as the CVD-growth parameters were fine tuned to obtain suboptimal regrowth yield, and thus favor single regrowth events. MWNT-catalyst conjugates (primary MWNTs) were localized and imaged before and after CVD growth in order to identify newly grown (secondary) MWNTs without ambiguity. Isolated CNT junctions were electrically connected using conventional e-beam lithography and the electrical characteristics of the MWNTs and the junction were measured.

Ferritin was coupled to MWNT through a well-known amide-bond strategy. For this purpose, carboxyl moieties were generated by acid treatment\textsuperscript{20} onto the aerosol-assisted CVD produced MWNTs.\textsuperscript{21} MWNTs were then incubated with carbodiimide and N-hydroxysuccinimide in aqueous buffer and reacted \textit{in situ} with ferritin\textsuperscript{20} in a ferritin/MWNT mass ratio of 3:2. The obtained MWNT-ferritin conjugates showed a quite high coverage with an average density of about 10 ferritin molecules per 100 nm of MWNT length as evidenced by transmission electron microscopy (TEM) [Fig. 1(a)].

FeO\textsubscript{x}NPs were obtained by precipitation of iron oleate in boiling dioctylether according to Park \textit{et al.}\textsuperscript{22} Due to the hydrophobicity of their oleate shell, FeO\textsubscript{x}NPs have a good affinity for MWNT and MWNT-FeO\textsubscript{x}NP conjugates were obtained by simply coincubating MWNT with FeO\textsubscript{x}NP (Ref. 20) (mass ratio 1:60). TEM images of the conjugates [Fig. 1(b)] showed MWNT covered with \textcircled{5} nm particles. The average coverage was about 40 FeO\textsubscript{x}NPs per 100 nm of MWNT length, which is noticeably higher than for MWNT-ferritin conjugates.
Prior to CVD growth, the samples were calcinated in air at 550 °C for 10 min to remove the organic shell. CNT growth was performed in an acetylene CVD reactor as described earlier. The reduction (H2, 20 min) of the iron oxide catalysts into Fe(0) was followed by CVD growth (C2H2, 10 min). We first checked that ferritin and FeO NP induced CNT growth in our CVD process and optimized the process for growth of small MWNTs on SiO2 substrates. MWNT growth was preferred to single walled nanotube for growth of small MWNTs on SiO2 substrates. MWNT-CNT growth in our CVD process and optimized the process for growth of small MWNTs on SiO2 substrates. MWNT growth was preferred to single walled nanotube (SWNT) (Ref. 24) growth from ferritin because individual CNT to CNT junction selection and electrical connection required scanning electron microscopy (SEM) imaging, the resolution of which does not allow individual SWNT detection. The CVD temperature was thus set at 700 °C to produce small MWNTs. In this process, ferritin and FeO NP deposited on a SiO2 substrate yielded MWNT of similar diameters (5–20 nm). In CVD regrowth from the MWNT-catalyst conjugates, the catalyst particles often appeared at the tip of the secondary MWNT [Figs. 1(c) and 1(d)], which suggests a tip-growth mechanism.

SEM images of the MWNT-catalyst conjugates after CVD regrowth are shown in Figs. 1(e) and 1(f). MWNT-FeO NP conjugates appear almost fully covered with packed particles, whereas MWNT-ferritin conjugates show sparse particles along the MWNT. In order to better control the FeO NP coverage, DEP-based electrodeposition was performed. MWNTs were first deposited using DEP by applying an ac voltage between electrodes on a chip covered with a drop of MWNT solution. The same procedure was then used for the deposition of FeO NP in toluene. The high aspect ratio of MWNTs increased DEP attraction toward their tip, favoring FeO NP deposition at the end of the contacted MWNT. Individual particles can be seen along the MWNT on Fig. 1(g).

Examples of individual CNT junctions are shown in Figs. 1(c) and 1(d). Secondary MWNTs were usually smaller and appeared brighter than primary MWNTs because they are protruding above the surface, therefore limiting electron transfer to the substrate. Unfortunately, their three-dimensional shape prevented metal connection by e-beam lithography. Therefore, we used a wetting/dewetting cycle in acetone to bend the protruding MWNTs under the meniscus pressure and have them stick to the substrate. After process optimization, approximately 100 CNT junctions were detected on a grid, from which approximately 20 were connected through e-beam lithography and metallization (Pd 5 nm/Au 50 nm).

A typical example of an electrically connected CNT junction structure and its current-voltage (I–V) characteristics is shown in Figs. 2(a) and 2(b). Statistics of the MWNT and junction conductances are shown in Figs. 2(c)–2(e). In all samples, secondary MWNTs were highly conducting (a few microamperes under 100 mV dc bias) and always showed a linear I–V curve. On the contrary, the primary MWNT conductance varied strongly according to the catalyst [Figs. 2(d) and 2(e)]. Their I–V curves were in most cases linear and symmetric, except for a slight S-shape in some highly resistive cases. All samples were fabricated using the same primary MWNTs and thus should show similar intrinsic conductances. The catalyst coupling method should not affect their conductance either since the organic shell around the catalyst was burnt out during calcination. Therefore, the strong conductivity drop in the case of MWNT-FeO NP was most likely due to the dense FeO NP coverage around the primary MWNTs, as can be seen in Fig. 1(f), which probably prevented direct electrical connection to the electrode.
drawback could nevertheless be overcome by the more controlled DEP deposition of FeO$_x$NP [Fig. 2(g)]. As a first estimate, although the contact resistance with the metal electrode could rise up as high as gigahms, the average conductance of the primary and secondary MWNTs lies probably in the 1 – 100 Ωs range, in good agreement with previous reports.7,9

In the case of the CNT junction, the measured conductance was limited by the bottleneck of the conductance path between the Au electrodes, which included two metal-MWNT contacts, two MWNT sections, and the CNT junction itself. The measured conductance of the CNT junction was usually intermediate between the conductance recorded for the primary and secondary MWNTs, which indicates that the CNT junction itself was not the conductance bottleneck. Our CNT junctions could sustain as high as 200 Ωs resistance, which implies that the catalyst particle moves away from the junction during the growth. A direct carbon on carbon connection is thus to be expected, as had been described in previous work.1,2

The effect of gating on the conductance was also studied using a silicon backgate.20 A very small or no change was observed in the conductance of CNT junctions and primary MWNTs. In the case of secondary MWNTs, a negative gate voltage produced a small (<50%) current increase. This is most likely due to some of the outer shells being semiconducting, as has been described for MWNTs of similar diameter.27

As a conclusion, the CNT junctions appeared to behave as low resistivity contact elements, as needed for CNT-CNT interconnect use in future electronics. Although the molecular structure of our CNT junctions could not be investigated in detail by TEM, high resolution SEM observation of our regrown sample indicates a probable tip growth process, which implies that the catalyst particle moves away from the junction during the growth. A direct carbon on carbon connection is thus to be expected, as had been described in previous work.1,2

Applying a versatile CVD-regrowth technique, we fabricated for the first time individual MWNT-MWNT junctions and characterized them electrically. Our method can be tuned to a large extent since catalysts could be bound to the initial growth. A direct carbon on carbon connection is thus to be expected, as had been described in previous work.1,2

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